

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT																
NATURE OF CONVEYANCE:	ASSIGNMENT																
CONVEYING PARTY DATA																	
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>JIEUN KIM</td> <td>12/03/2013</td> </tr> <tr> <td>YONG HWAN KWON</td> <td>12/03/2013</td> </tr> <tr> <td>JIHONG KIM</td> <td>12/03/2013</td> </tr> <tr> <td>HYERYUNG KIM</td> <td>12/03/2013</td> </tr> <tr> <td>JANGWON SEO</td> <td>12/03/2013</td> </tr> <tr> <td>SERAN JEON</td> <td>12/03/2013</td> </tr> <tr> <td>WOO-SEOK HWANG</td> <td>12/03/2013</td> </tr> </tbody> </table>		Name	Execution Date	JIEUN KIM	12/03/2013	YONG HWAN KWON	12/03/2013	JIHONG KIM	12/03/2013	HYERYUNG KIM	12/03/2013	JANGWON SEO	12/03/2013	SERAN JEON	12/03/2013	WOO-SEOK HWANG	12/03/2013
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<table border="1"> <tr> <td>Name:</td> <td>SAMSUNG ELECTRONICS CO., LTD.</td> </tr> <tr> <td>Street Address:</td> <td>129, SAMSUNG-RO, YEONGTONG-GU, SUWON-SI, GYEONGGI-DO 443-742</td> </tr> <tr> <td>City:</td> <td>SUWON-SI</td> </tr> <tr> <td>State/Country:</td> <td>KOREA, REPUBLIC OF</td> </tr> </table>		Name:	SAMSUNG ELECTRONICS CO., LTD.	Street Address:	129, SAMSUNG-RO, YEONGTONG-GU, SUWON-SI, GYEONGGI-DO 443-742	City:	SUWON-SI	State/Country:	KOREA, REPUBLIC OF								
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<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>29475552</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	29475552												
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Application Number:	29475552																
CORRESPONDENCE DATA																	
Fax Number:	(202)315-3758																
Phone:	2024290020																
Email:	pto@nsiplaw.com																
<i>Correspondence will be sent via US Mail when the email attempt is unsuccessful.</i>																	
Correspondent Name:	NSIP LAW																
Address Line 1:	PO BOX 65745																
Address Line 4:	WASHINGTON, DISTRICT OF COLUMBIA 20035																
ATTORNEY DOCKET NUMBER:	D91058.0176																
NAME OF SUBMITTER:	SHABNAM NOWROUZI																

PATENT

Signature:	/Shabnam Nowrouzi/
Date:	03/06/2014
Total Attachments: 4 source=NewDesApp_D910580176_Assign_AsFiled#page1.tif source=NewDesApp_D910580176_Assign_AsFiled#page2.tif source=NewDesApp_D910580176_Assign_AsFiled#page3.tif source=NewDesApp_D910580176_Assign_AsFiled#page4.tif	

COMBINED DECLARATION AND ASSIGNMENT UNDER 37 CFR 1.63(e)

DECLARATION

As a below-named inventor, I hereby declare that this declaration is directed to the application attached hereto, or to United States Application Number or PCT International Application Number

_____ filed on _____ (if applicable), entitled:

DISPLAY SCREEN OR PORTION THEREOF WITH GRAPHIC USER INTERFACE

The above-identified application was made or authorized to be made by me.

I believe I am the original inventor or an original joint inventor of a claimed invention in the above-identified application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 USC 1001 by fine or imprisonment of not more than five (5) years, or both.

I have reviewed and understand the contents of the above-identified application, including the claims.

I am aware of the duty to disclose to the United States Patent and Trademark Office all information known to me to be material to patentability as defined in 37 CFR 1.56, including for continuation-in-part applications, material information that became available between the filing date of the prior application and the national or PCT international filing date of the continuation-in-part application.

ASSIGNMENT

For valuable consideration, I, as a below-named assignor, hereby assign to:

Samsung Electronics Co., Ltd.
129, Samsung-ro, Yeongtong-gu
Suwon-si, Gyeonggi-do, 443-742
Republic of Korea


and its successors and assigns (collectively hereinafter called "the Assignee"), the entire right, title, and interest throughout the world in the inventions and improvements that are the subject of the application identified in the above declaration, which is United States Application Number or PCT International Application Number 29/475,552 filed on December 4, 2013.

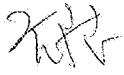
I authorize and request the attorneys appointed in the above-identified application to hereafter complete this Assignment by inserting above the application number and the filing date of the above-identified

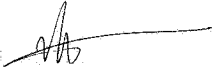
application when known, and to correct any typographical errors that may be discovered in this Assignment.

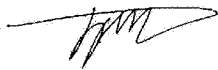
This Assignment includes the above-identified application, any and all United States and foreign patents, utility models, and design registrations granted for any of the inventions and improvements that are the subject of the above-identified application, and the right to claim priority based on the filing date of the above-identified application under the International Convention for the Protection of Industrial Property, the Patent Cooperation Treaty, the European Patent Convention, and all other treaties of like purposes; and I authorize the Assignee to apply in all countries in my name or in its own name for patents, utility models, design registrations, like rights of exclusion, and inventors' certificates for any of the inventions and improvements that are the subject of the above-identified application; and I agree for myself and my heirs, legal representatives, and assigns without further compensation to perform such lawful acts and to sign such further applications, Assignments, preliminary statements, and other lawful documents as the Assignee may reasonably request to effectuate fully this Assignment.

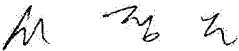
In witness whereof, I, as a below-named inventor and assignor, intending to be legally bound, have hereunto affixed my signature on the date indicated below next to my signature.


Inventor's Legal Name	Jieun KIM		
Inventor's Signature		Date	December 3, 2013
Residence (City, Country)	Suwon-si, Republic of Korea		
Mailing Address	#308, 384-16 Shin-dong, Youngtong-gu, Suwon-si, Gyeonggi-do, Republic of Korea		

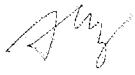
Inventor's Legal Name	Yong Hwan KWON		
Inventor's Signature		Date	December 3, 2013
Residence (City, Country)	Seongnam-si, Republic of Korea		
Mailing Address	202-2903, I-Park Bundang, Jeongja-dong, Bundang-gu, Seongnam-si, Gyeonggi-do, Republic of Korea		

Inventor's Legal Name	Jihong KIM		
Inventor's Signature		Date	December 3, 2013
Residence (City, Country)	Seoul, Republic of Korea		
Mailing Address	102-1301 Kyunghyang Rexvill, Sangdo-dong, Dongjak-gu, Seoul, Republic of Korea		

Inventor's Legal Name	Hyeryung KIM		
Inventor's Signature		Date	December 3, 2013
Residence (City, Country)	Seongnam-si, Republic of Korea		
Mailing Address	406-1203 Hansolmaul Jugong 4danji Apt., Jeongja-dong, Bundang-gu, Seongnam-si, Gyeonggi-do, Republic of Korea		

Inventor's Legal Name	Jangwon SEO		
Inventor's Signature		Date	December 3, 2013
Residence (City, Country)	Seoul, Republic of Korea		
Mailing Address	203ho Haerim Art villa Daelim-dong, Yeondungpo-gu, Seoul, Republic of Korea		

Inventor's Legal Name	Seran JEON		
Inventor's Signature		Date	December 3, 2013
Residence (City, Country)	Seoul, Republic of Korea		
Mailing Address	101-503 Seocho Raemian Apt., Seocho-4dong, Soecho-gu, Seoul, Republic of Korea		

Inventor's Legal Name	Woo-Seok HWANG		
Inventor's Signature		Date	December 3, 2013
Residence (City, Country)	Seoul, Republic of Korea		
Mailing Address	205-405 4cha ShinBanpo Apt.70, Jamwon-dong, Seocho-gu, Seoul, Republic of Korea		